

PAL16L8AM, PAL16L8A-2M, PAL16R4AM, PAL16R4A-2M PAL16R6AM, PAL16R6A-2M, PAL16R8AM, PAL16R8A-2M STANDARD HIGH-SPEED PAL[®] CIRCUITS

SRPS016 – D2705, FEBRUARY 1984 – REVISED MARCH 1992

- **Choice of Operating Speeds**
High-Speed, A Devices . . . 25 MHz Min
Half-Power, A-2 Devices . . . 16 MHz Min
- **Choice of Input/Output Configuration**
- **Package Options Include Both Ceramic DIP and Chip Carrier in Addition to Ceramic Flat Package**

DEVICE	I INPUTS	3-STATE O OUTPUTS	REGISTERED Q OUTPUTS	I/O PORT S
PAL16L8	10	2	0	6
PAL16R4	8	0	4 (3-state buffers)	4
PAL16R6	8	0	6 (3-state buffers)	2
PAL16R8	8	0	8 (3-state buffers)	0

description

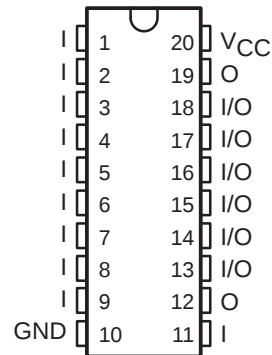
These programmable array logic devices feature high speed and a choice of either standard or half-power devices. They combine Advanced Low-Power Schottky technology with proven titanium-tungsten fuses. These devices will provide reliable, high-performance substitutes for conventional TTL logic. Their easy programmability allow for quick design of "custom" functions and typically results in a more compact circuit board. In addition, chip carriers are available for further reduction in board space.

The Half-Power versions offer a choice of operating frequency, switching speeds, and power dissipation. In many cases, these Half-Power devices can result in significant power reduction from an overall system level.

The PAL16' M series is characterized for operation over the full military temperature range of –55°C to 125°C.

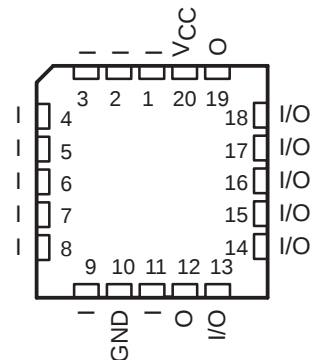
**PAL16L8'
J OR W PACKAGE**

(TOP VIEW)



**PAL16L8'
FK PACKAGE**

(TOP VIEW)



PAL is a registered trademark of Advanced Micro Devices Inc.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



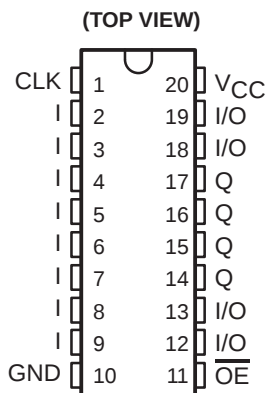
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1992, Texas Instruments Incorporated

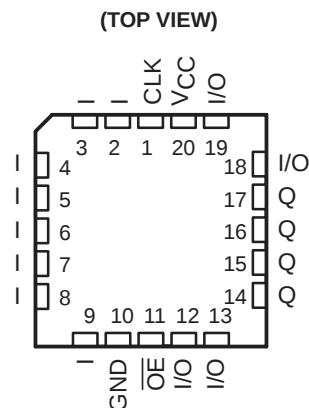
PAL16R4AM, PAL16R4A-2M, PAL16R6AM, PAL16R6A-2M, PAL16R8AM, PAL16R8A-2M STANDARD HIGH-SPEED PAL[®] CIRCUITS

SRPS016 – D2705, FEBRUARY 1984 – REVISED MARCH 1992

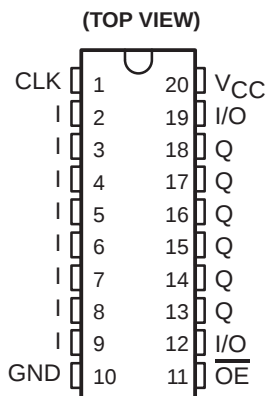
PAL16R4'
J OR W PACKAGE



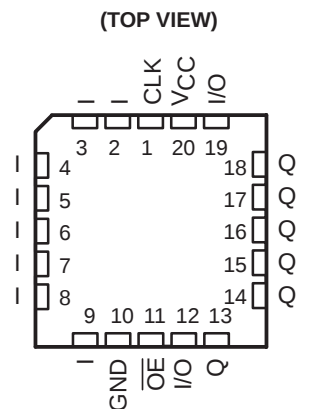
PAL16R4'
FK PACKAGE



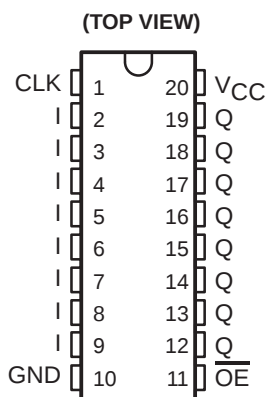
PAL16R6'
J OR W PACKAGE



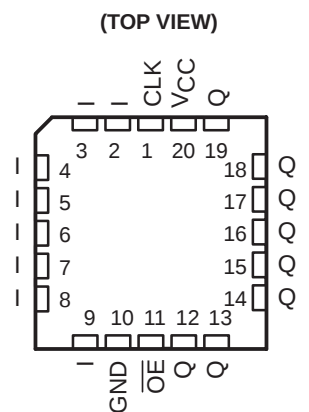
PAL16R6'
FK PACKAGE



PAL16R8'
J OR W PACKAGE



PAL16R8'
FK PACKAGE



SRPS016 – D2705, FEBRUARY 1984 – REVISED MARCH 1992

PAL16L8AM
PAL16L8A-2M

10/ 16/ 6/ 16/ 7/ 7/ 7/ 7/ 7/ 7/ 7/ 7/ 6/

16 x ▸

&
32 X 64

EN ≥ 1 ▽

I/O I/O I/O I/O I/O I/O

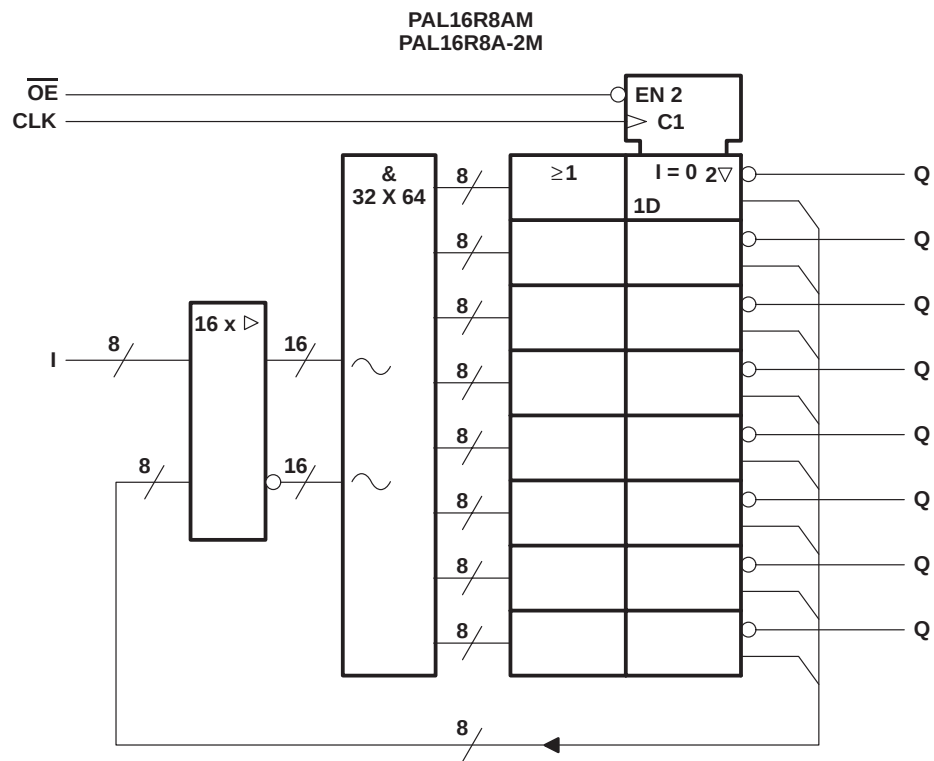
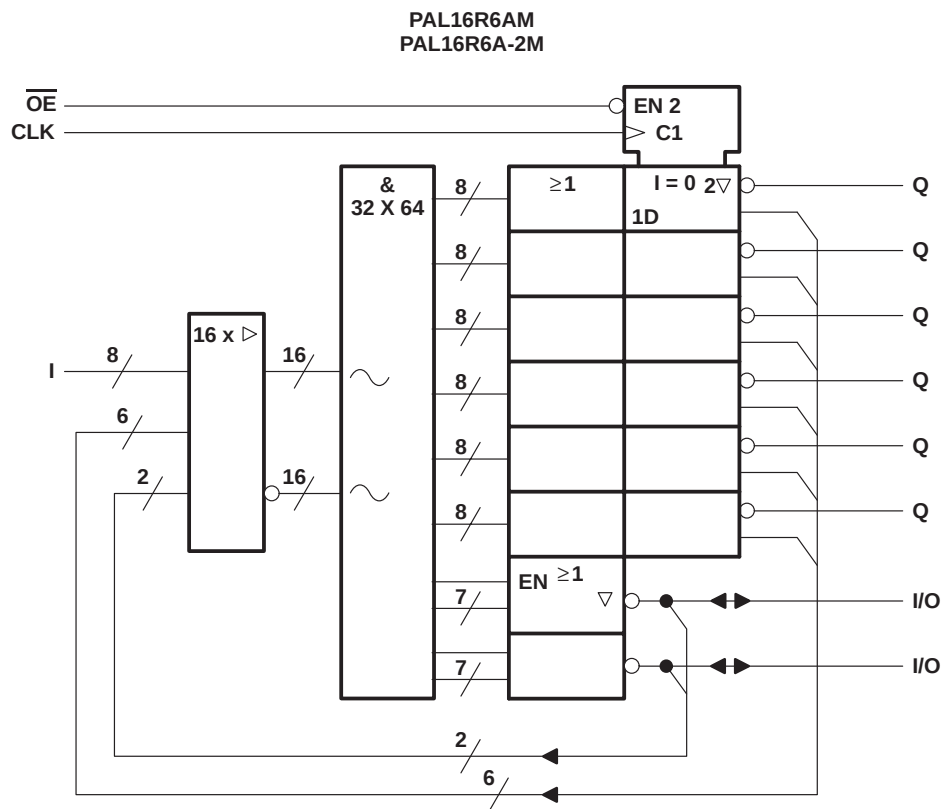
[illegible]

TEXAS 
INSTRUMENTS
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

PAL16R6AM, PAL16R6A-2M, PAL16R8AM, PAL16R8A-2M STANDARD HIGH-SPEED PAL[®] CIRCUITS

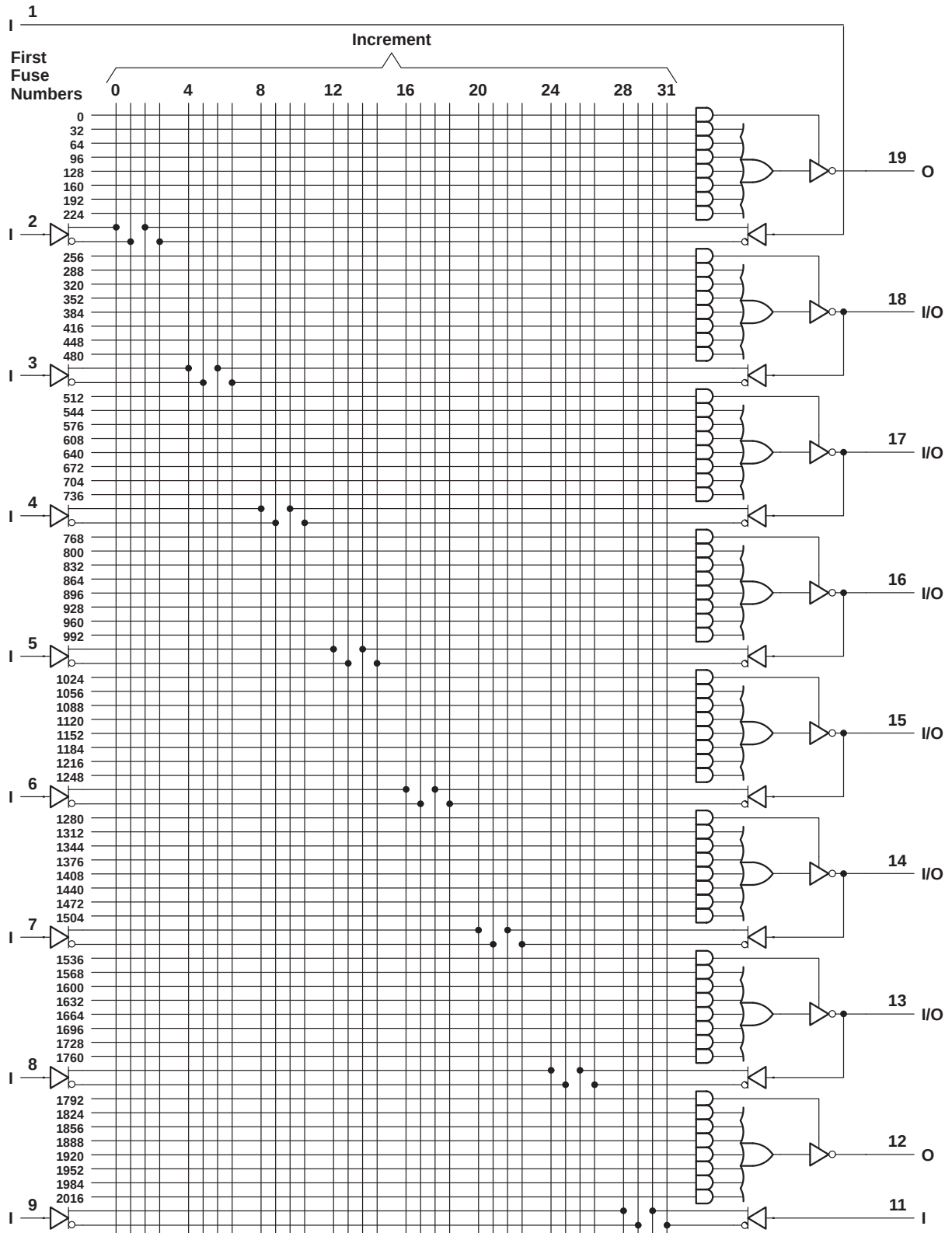
SRPS016 – D2705, FEBRUARY 1984 – REVISED MARCH 1992

functional block diagrams (positive logic)



~ denotes fused inputs

logic diagram (positive logic)

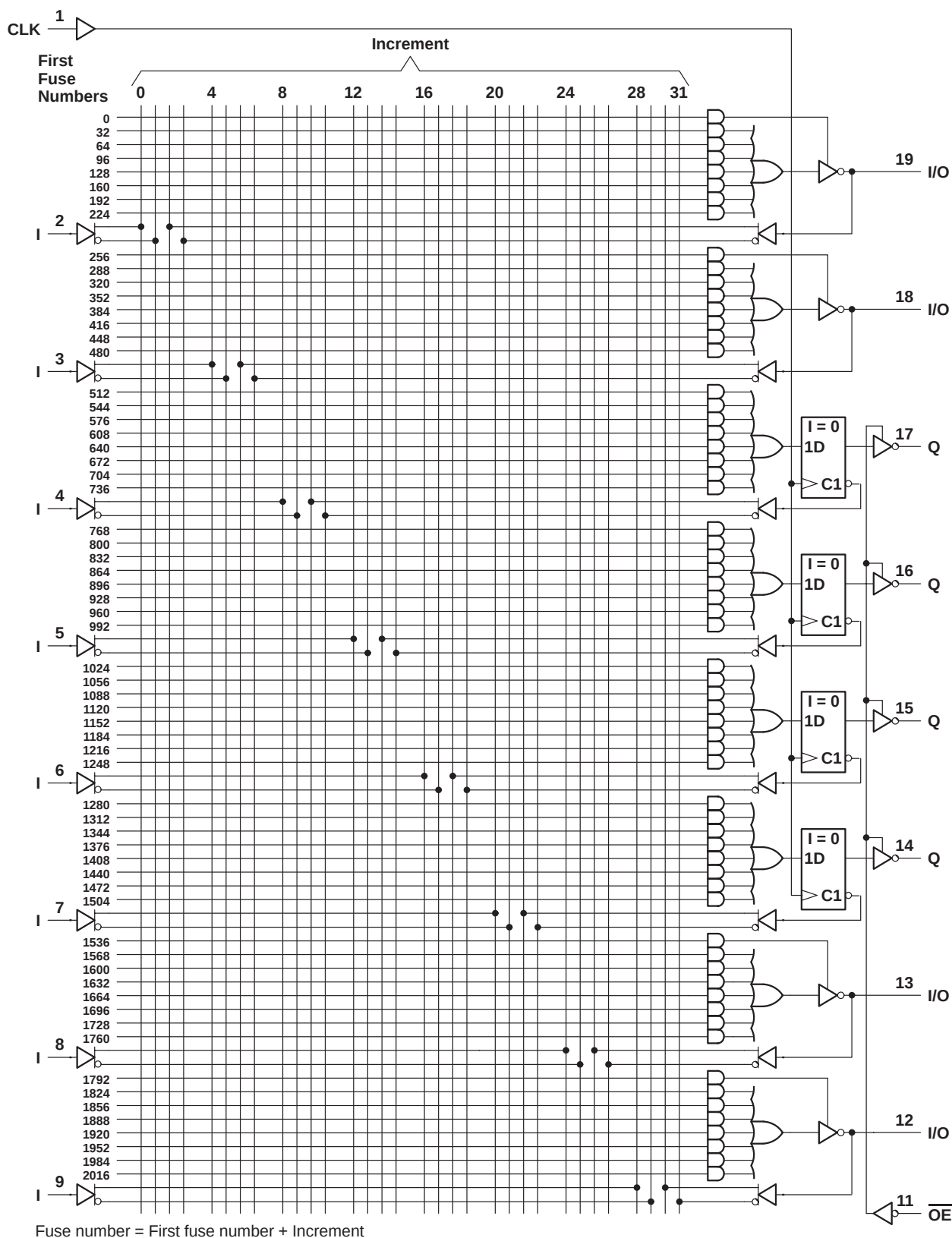


Fuse number = First fuse number + Increment

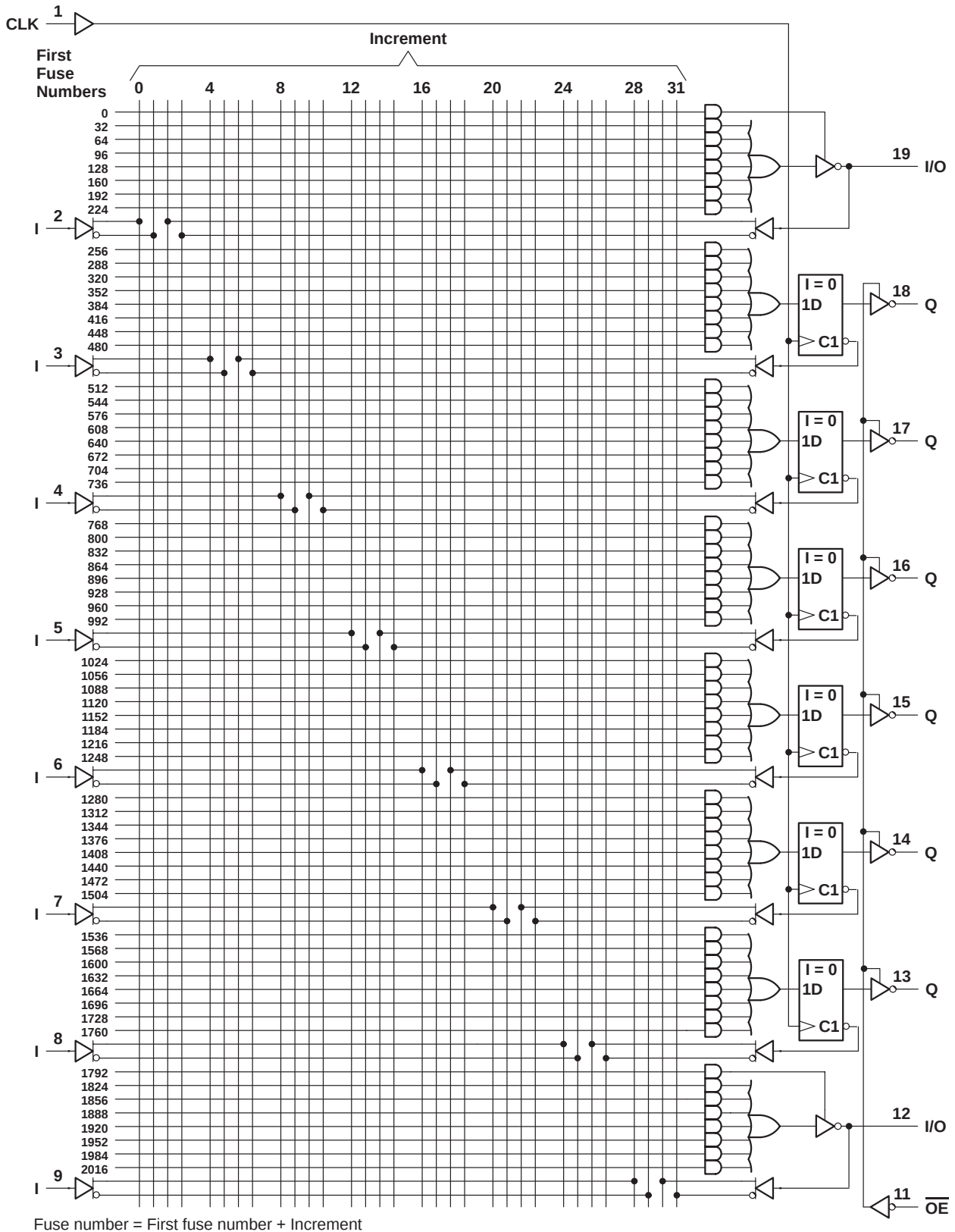
PAL16R4AM, PAL16R4A-2M STANDARD HIGH-SPEED PAL[®] CIRCUITS

SRPS016 – D2705, FEBRUARY 1984 – REVISED MARCH 1992

logic diagram (positive logic)



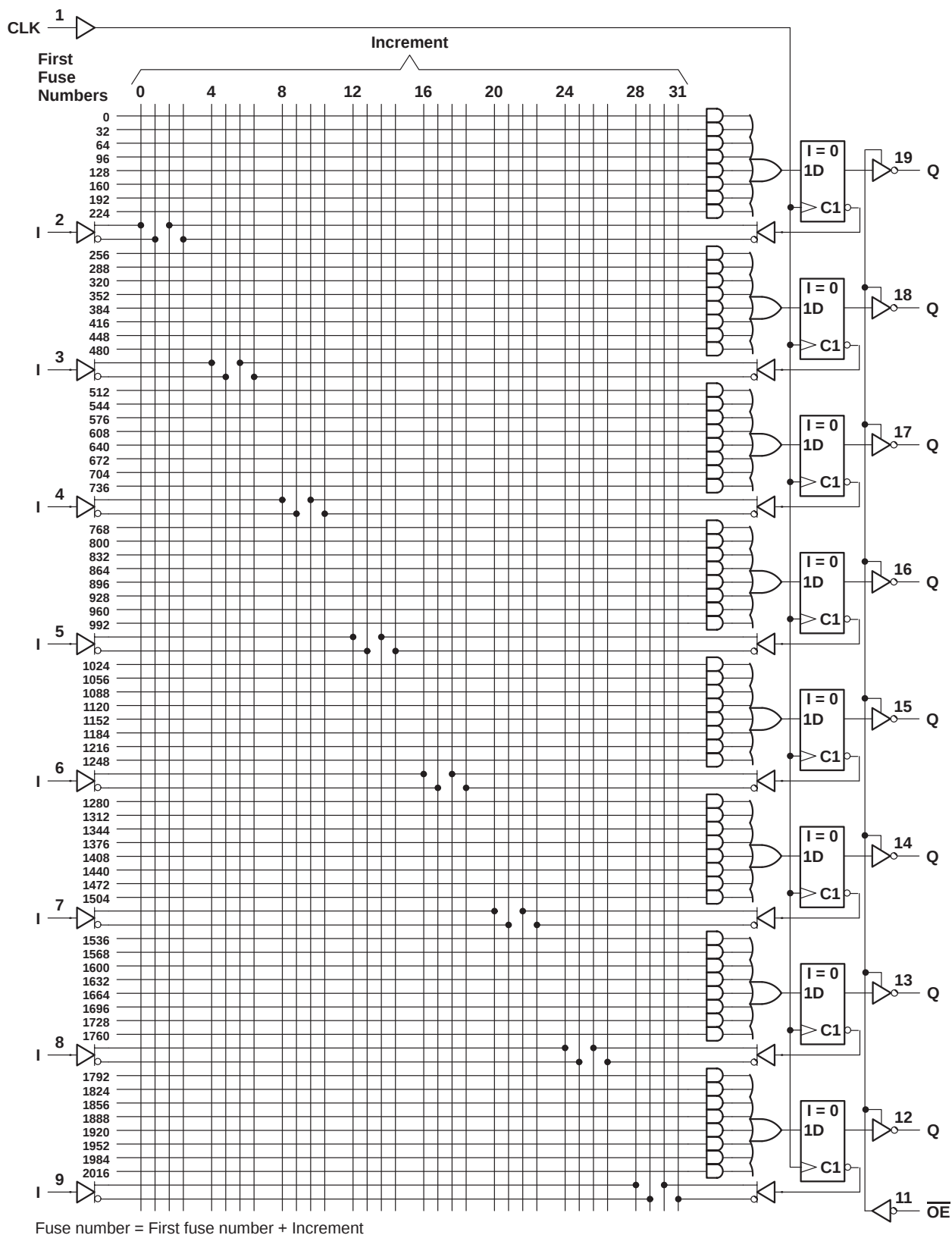
logic diagram (positive logic)



PAL16R8AM, PAL16R8A-2M STANDARD HIGH-SPEED PAL[®] CIRCUITS

SRPS016 – D2705, FEBRUARY 1984 – REVISED MARCH 1992

logic diagram (positive logic)



programming information

Texas Instruments programmable logic devices can be programmed using widely available software and inexpensive device programmers.

Complete programming specifications, algorithms, and the latest information on hardware, software, and firmware are available upon request. Information on programmers capable of programming Texas Instruments programmable logic is also available, upon request, from the nearest TI field sales office, local authorized TI distributor, or by calling Texas Instruments at (214) 997-5666.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage (see Note 1)	5.5 V
Voltage applied to disabled output (see Note 1)	5.5 V
Operating free-air temperature range	–55°C to 125°C
Storage temperature range	–65°C to 150°C

NOTE 1: These ratings apply except for programming pins during a programming cycle.

recommended operating conditions

		MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage	4.5	5	5.5	V
V_{IH}	High-level input voltage	2		5.5	V
V_{IL}	Low-level input voltage			0.8	V
I_{OH}	High-level output current			–2	mA
I_{OL}	Low-level output current			12	mA
T_A	Operating free-air temperature	–55	25	125	°C

PAL16L8AM, PAL16R4AM, PAL16R6AM, PAL16R8AM STANDARD HIGH-SPEED PAL[®] CIRCUITS

SRPS016 – D2705, FEBRUARY 1984 – REVISED MARCH 1992

electrical characteristics over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS		MIN	TYP [†]	MAX	UNIT
V_{IK}		$V_{CC} = 4.5\text{ V}$,	$I_I = -18\text{ mA}$			-1.5	V
V_{OH}		$V_{CC} = 4.5\text{ V}$,	$I_{OH} = -2\text{ mA}$	2.4	3.2		V
V_{OL}		$V_{CC} = 4.5\text{ V}$,	$I_{OL} = 12\text{ mA}$		0.25	0.4	V
I_{OZH}	Outputs	$V_{CC} = 5.5\text{ V}$,	$V_O = 2.7\text{ V}$			20	μA
	I/O ports					100	
I_{OZL}	Outputs	$V_{CC} = 5.5\text{ V}$,	$V_O = 0.4\text{ V}$			-20	μA
	I/O ports					-100	
I_I		$V_{CC} = 5.5\text{ V}$,	$V_I = 5.5\text{ V}$			0.2	mA
I_{IH}	I/O Ports	$V_{CC} = 5.5\text{ V}$,	$V_I = 2.7\text{ V}$			100	μA
	All others					25	
I_{IL}	$\overline{\text{OE}}$ input	$V_{CC} = 5.5\text{ V}$,	$V_I = 0.4\text{ V}$			-0.2	mA
	All others					-0.1	
$I_{OS}^{\ddagger}$		$V_{CC} = 5.5\text{ V}$,	$V_O = 0.5\text{ V}$	-30		-250	mA
I_{CC}		$V_{CC} = 5.5\text{ V}$,	$V_I = 0$, Outputs open		75	180	mA

timing requirements

			MIN	MAX	UNIT
f_{clock}	Clock Frequency		0	25	MHz
t_w	Pulse duration (see Note 2)	Clock high	15		ns
		Clock low	20		
t_{su}	Setup time, input or feedback before $\text{CLK}\uparrow$		25		ns
t_h	Hold time, input or feedback after $\text{CLK}\uparrow$		0		ns

NOTE 2: The total clock period of clock high and clock low must not exceed clock frequency, f_{clock} . The minimum pulse durations specified are only for clock high or low, but not for both simultaneously.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITION	MIN	TYP [†]	MAX	UNIT
f_{max}			R1 = 390 Ω , R2 = 750 Ω , See Figure 1	25	45		MHz
t_{pd}	I, I/O	O, I/O			15	30	ns
t_{pd}	$\text{CLK}\uparrow$	Q			10	20	ns
t_{en}	$\overline{\text{OE}}\downarrow$	Q			15	25	ns
t_{dis}	$\overline{\text{OE}}\uparrow$	Q			10	25	ns
t_{en}	I, I/O	O, I/O			14	30	ns
t_{dis}	I, I/O	O, I/O			13	30	ns

[†] All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

[‡] Not more than one output should be shorted at a time and the duration of the short circuit should not exceed one second. Set V_O at 0.5 V to avoid test equipment degradation.

PAL16L8A-2M, PAL16R4A-2M, PAL16R6A-2M, PAL16R8A-2M STANDARD HIGH-SPEED PAL® CIRCUITS

SRPS016 – D2705, FEBRUARY 1984 – REVISED MARCH 1992

electrical characteristics over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS		MIN	TYP [†]	MAX	UNIT
V_{IK}		$V_{CC} = 4.5\text{ V}$,	$I_I = -18\text{ mA}$			-1.5	V
V_{OH}		$V_{CC} = 4.5\text{ V}$,	$I_{OH} = -2\text{ mA}$	2.4	3.2		V
V_{OL}		$V_{CC} = 4.5\text{ V}$,	$I_{OL} = 12\text{ mA}$		0.25	0.4	V
I_{OZH}	Outputs	$V_{CC} = 5.5\text{ V}$,	$V_O = 2.7\text{ V}$			20	μA
	I/O ports					100	
I_{OZL}	Outputs	$V_{CC} = 5.5\text{ V}$,	$V_O = 0.4\text{ V}$			-20	μA
	I/O ports					-100	
I_I		$V_{CC} = 5.5\text{ V}$,	$V_I = 5.5\text{ V}$			0.2	mA
I_{IH}	I/O Ports	$V_{CC} = 5.5\text{ V}$,	$V_I = 2.7\text{ V}$			100	μA
	All others					25	
I_{IL}	$\overline{OE}$ input	$V_{CC} = 5.5\text{ V}$,	$V_I = 0.4\text{ V}$			-0.2	mA
	All others					-0.1	
$I_{OS}^{\ddagger}$		$V_{CC} = 5.5\text{ V}$,	$V_O = 0.5\text{ V}$	-30		-250	mA
I_{CC}		$V_{CC} = 5.5\text{ V}$,	$V_I = 0$, Outputs open		75	90	mA

timing requirements

			MIN	MAX	UNIT
f_{clock}	Clock Frequency		0	16	MHz
t_w	Pulse duration (see Note 2)	Clock high	25		ns
		Clock low	25		
t_{su}	Setup time, input or feedback before $\text{CLK}\uparrow$		35		ns
t_h	Hold time, input or feedback after $\text{CLK}\uparrow$		0		ns

NOTE 2: The total clock period of clock high and clock low must not exceed clock frequency, f_{clock} . The minimum pulse durations specified are only for clock high or low, but not for both simultaneously.

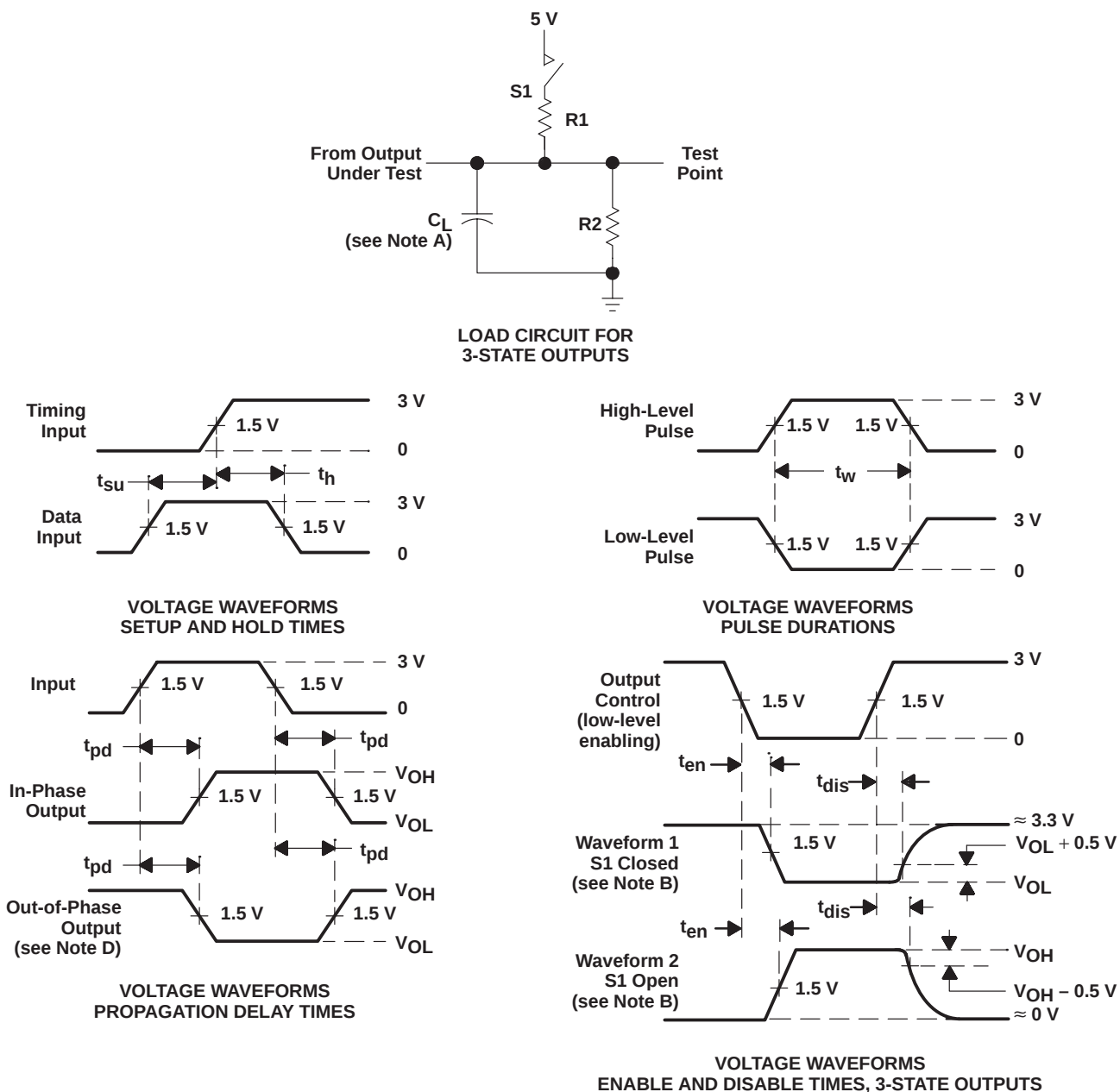
switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITION	MIN	TYP [†]	MAX	UNIT
f_{max}			R1 = 390 Ω , R2 = 750 Ω , See Figure 1	16	25		MHz
t_{pd}	I, I/O	O, I/O			25	40	ns
t_{pd}	$\text{CLK}\uparrow$	Q			11	25	ns
t_{en}	$\overline{OE}\downarrow$	Q			20	25	ns
t_{dis}	$\overline{OE}\uparrow$	Q			11	25	ns
t_{en}	I, I/O	O, I/O			25	40	ns
t_{dis}	I, I/O	O, I/O			25	35	ns

[†] All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

[‡] Not more than one output should be shorted at a time and the duration of the short circuit should not exceed one second. Set V_O at 0.5 V to avoid test equipment degradation.

PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance and is 50 pF for t_{pd} and t_{en} , 5 pF for t_{dis} .
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses have the following characteristics: $PRR \leq 10$ MHz, t_r and $t_f \leq 2$ ns, duty cycle = 50%
 D. When measuring propagation delay times of 3-state outputs, switch S1 is closed.
 E. Equivalent loads may be used for testing.

Figure 1. Load Circuit and Voltage Waveforms

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.